

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Wen-Yi Su :
Parent S.N. : 10/243,723 : Group Art Unit #
Filed : 16 September 2002

Serial No. : : Examiner:
Filed :

Title : THERMOPLASTIC STYRENIC :
RESIN COMPOSITION

PRELIMINARY AMENDMENT

Mail Stop NO FEE
Honorable Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Applicant, by the undersigned attorney hereby submits a Preliminary Amendment for the above-referenced application. The subject application is a Divisional Application for Parent Application Serial No. 10/243,723. Please amend the above-referenced application as follows:

Amendment to the Claims are reflected in the Listing of Claims which begins on page 2 of this paper.

Remarks/Arguments being on page 4 of this paper.